

2A, 200V - 1000V Fast Recovery Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Glass passivated chip junction
- Ideal for automated placement
- Low power loss, high efficiency
- · Fast switching for high efficiency
- Low profile package
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

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- Freewheeling
- Snubber
- DC/DC converters
- Automotive application

MECHANICAL DATA

• Case: SOD-128

• Molding compound meets UL 94V-0 flammability rating

• Terminal: Matte tin plated leads, solderable per J-STD-002

Meet JESD 201 class 2 whisker test

Polarity: Indicated by cathode band

• Weight: 0.027g (approximately)

KEY PARAMETERS				
PARAMETER	VALUE	UNIT		
l _F	2	Α		
V_{RRM}	200 - 1000	V		
I _{FSM}	50	Α		
T_{JMAX}	150	°C		
Package	SOD-128			
Configuration	Single die			





SOD-128



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)								
PARAMETER		SYMBOL	RS2D	RS2G	RS2J	RS2K	RS2M	UNIT
			FSH	FSH	FSH	FSH	FSH	
Marking code on the device			RS2DFH	RS2GFH	RS2JFH	RS2KFH	RS2MFH	
Repetitive peak reverse voltage		V_{RRM}	200	400	600	800	1000	V
Reverse voltage, total rms value		$V_{R(RMS)}$	140	280	420	560	700	V
Forward current		I _F	2				Α	
Surge peak forward current,	t = 8.3ms				50			Α
single half sine-wave superimposed on rated load	t = 1.0ms	I _{FSM}	140					Α
Junction temperature		T_J	-55 to +150				°C	
Storage temperature		T _{STG}	-55 to +150				°C	

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THERMAL PERFORMANCE					
PARAMETER	SYMBOL	TYP	UNIT		
Junction-to-lead thermal resistance	$R_{\Theta JL}$	16	°C/W		
Junction-to-ambient thermal resistance	R _{eJA}	73	°C/W		
Junction-to-case thermal resistance	R _{eJC}	14	°C/W		

Thermal Performance Note: Units mounted on PCB (5mm x 5mm Cu pad test board)

PARAMET	ER	CONDITIONS S	SYMBOL	TYP	MAX	UNIT
				0.93	-	V
	RS2DFSH	I _F = 2A, T _J = 25°C		1.01	1.30	V
	RS2GFSH RS2JFSH	I _F = 1A, T _J = 125°C		0.78	-	V
Command valtage (1)		I _F = 2A, T _J = 125°C		0.88	1.02	V
Forward voltage ⁽¹⁾		I _F = 1A, T _J = 25°C	V _F	0.98	-	V
	RS2KFSH	I _F = 2A, T _J = 25°C		1.06	1.30	V
	RS2MFSH	I _F = 1A, T _J = 125°C		0.83	-	V
		I _F = 2A, T _J = 125°C		0.93	1.05	V
- (2)		T _J = 25°C		-	1	μΑ
Reverse current @ rated V _R	,	T _J = 125°C	l _R	-	40	μΑ
	RS2DFSH RS2GFSH	I _F = 0.5A, I _R = 1.0A, I _{rr} = 0.25A	t _{rr}	-	150	ns
Reverse recovery time	RS2JFSH			-	250	ns
	RS2KFSH RS2MFSH	- III - 0.2071		-	500	ns
Junction capacitance	RS2DFSH RS2GFSH RS2JFSH	1MHz, V _B = 4.0V	CJ	11	-	pF
	RS2KFSH RS2MFSH	, , , ,		10	-	pF

Notes:

- (1) Pulse test with PW = 0.3ms
- (2) Pulse test with PW = 30ms

ORDERING INFORMATION					
ORDERING CODE ⁽¹⁾	PACKAGE	PACKING			
RS2xFSH	SOD-128	14,000 / Tape & Reel			

Notes:

(1) "x" defines voltage from 200V(RS2DFSH) to 1000V(RS2MFSH)



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve

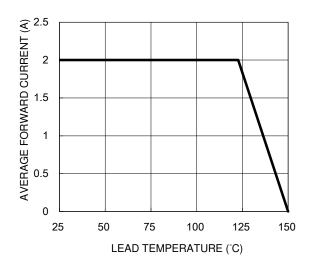


Fig.3 Typical Reverse Characteristics

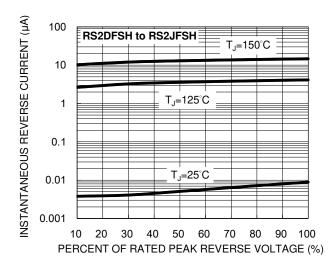


Fig.5 Typical Reverse Characteristics

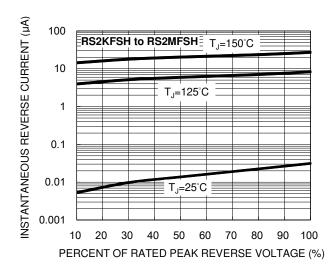


Fig.2 Typical Junction Capacitance

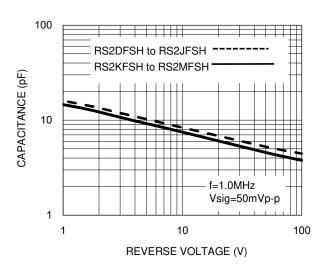


Fig.4 Typical Forward Characteristics

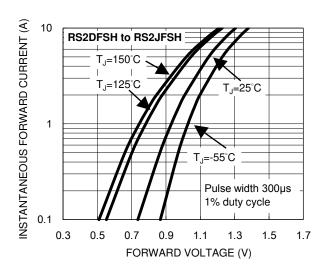
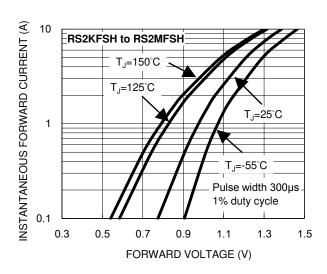


Fig.6 Typical Forward Characteristics

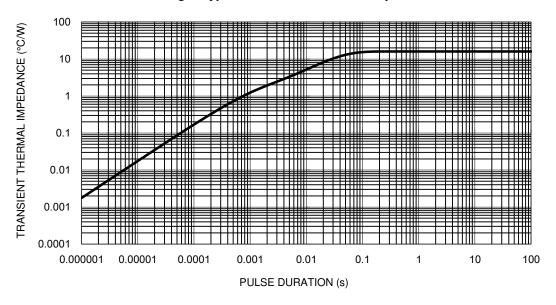




CHARACTERISTICS CURVES

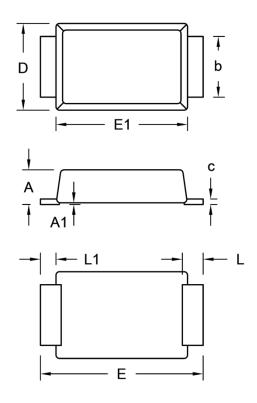
 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.7 Typical Transient Thermal Impedance



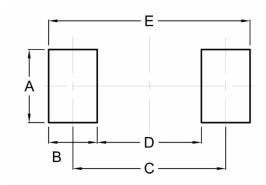
PACKAGE OUTLINE DIMENSIONS

SOD-128



DIM.	Unit	(mm)	Unit (inch)		
DIW.	Min.	Max.	Min.	Max.	
Α	0.90	1.10	0.035	0.043	
A1	0.00	0.10	0.000	0.004	
b	1.60	1.90	0.063	0.075	
С	0.10	0.22	0.004	0.009	
D	2.30	2.70	0.091	0.106	
E	4.40	5.00	0.173	0.197	
E1	3.60	4.00	0.142	0.157	
L	0.40	0.80	0.016	0.031	
L1	0.30	0.60	0.012	0.024	

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
Α	2.10	0.083
В	1.40	0.055
С	4.40	0.173
D	3.00	0.118
E	5.80	0.228

MARKING DIAGRAM



P/N = Marking Code YW = Date Code F = Factory Code



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